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PATENT
Docket No.: 018865-004210US
Client Ref. No.: 17732.13420.003
(divisional)

Leonardo Andujar

2826

RESPONSE TO RESTRICTION

Mail Stop Amendment Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

On 61

TOWNSEND and CREW LLP

By: Jusa Karsen

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Examiner:

Art Unit:

REQUIREMENT

In re application of:

Joshi et al.

Application No.: 10/607,633

Filed: June 27, 2003

For: FLIP CHIP IN LEADED MOLDED

PACKAGE AND METHOD OF MANUFACTURE THEREOF

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In the Office Action mailed May 7, 2004, the Examiner restricts the claims into two Groups, Group I (claims 1-5) and Group II (claims 7-17).

In response to the Office Action, Applicants elect Group II, claims 7-17, drawn to a method of manufacturing a semiconductor device, for prosecution on the merits, with traverse.



≟Joshi et al. ⇒Application No.: 10/607,633 ⇒Page 2

An Office Action on the merits is respectfully requested.

Respectfully submitted,

Patrick R. Jewik Reg. No. 40,456

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PRJ:lyk

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